TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC74AP, TC74HC74AF

Dual D-Type Flip Flop Preset and Clear

The TC74HC74A is a high speed CMOS D FLIP FLOP fabricated with silicon gate C^2 MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The signal level applied to the D INPUT is transferred to Q OUTPUT during the positive going transition of the CLOCK pulse.

CLEAR and PRESET are independent of the CLOCK and are accomplished by setting the appropriate input to an "L" level.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

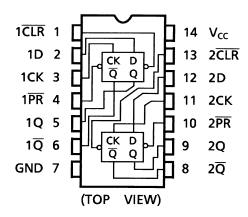
- High speed: $f_{max} = 77 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 2 \mu A$ (max) at $T_{a} = 25^{\circ}C$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 4 \text{ mA (min)}$
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS74

DIP14-P-300-2.54 TC74HC74AF SOP14-P-300-1.27A

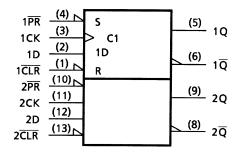
Weight

DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.)

Pin Assignment



IEC Logic Symbol

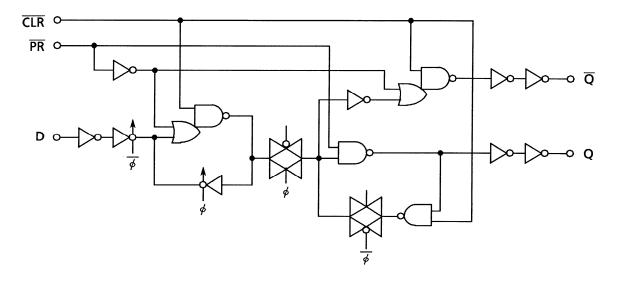


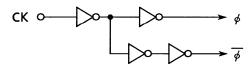
Truth Table

	Inp	uts		Out	puts	Function		
CLR	PR	D	CK	Q	IQ	Tunction		
L	Н	Х	Х	L	Н	Clear		
I	L	Х	Х	H L		Preset		
٦	L	Х	Х	Н	Н	_		
Н	Н	L		L	Н			
Н	Н	Н		Н	L			
Н	Н	Х	\Box	Qn	\overline{Q}_{n}	No Change		

X: Don't care

System Diagram







Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	−0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	٧
Operating temperature	T _{opr}	−40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
	,			V _{CC} (V)	Min	Тур.	Max	Min	Max	
				2.0	1.50	_	_	1.50	_	
High-level input voltage	V _{IH}	_		4.5	3.15	_	_	3.15	_	V
				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V_{IL}	_		4.5	_	_	1.35	_	1.35	V
				6.0	_	_	1.80	_	1.80	
	V _{ОН}	V _{IN} = V _{IH} or V _{IL}		2.0	1.9	2.0	_	1.9	_	
			I _{OH} = -20 μA	4.5	4.4	4.5	_	4.4	_	
High-level output voltage				6.0	5.9	6.0	_	5.9	_	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80		5.63	_	
	V _{OL}			2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage		V _{IN} = V _{IH} or V _{IL}		6.0	_	0.0	0.1	_	0.1	V
			$I_{OL} = 4 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
			$I_{OL} = 5.2 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0		_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or	GND	6.0	_	_	2.0	_	20.0	μА



Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	1	Ta =	25°C	Ta = -40 to 85°C	Unit
onaractoriosico	5,5		V _{CC} (V)	Тур.	Limit	Limit	5 1t
Minimum pulse width	5		2.0	_	75	95	
(CK)	tw (L)	_	4.5	_	15	19	ns
(CK)	t _{W (H)}		6.0	_	13	16	
Minimum nulae width			2.0	_	75	95	
Minimum pulse width (CLR, PR)	t _{W (L)}	_	4.5	_	15	19	ns
(CLR, PR)			6.0	_	13	16	
			2.0	_	75	95	
Minimum set-up time	t _s	_	4.5	_	15	19	ns
			6.0	_	13	16	
	t _h	_	2.0	_	0	0	
Minimum hold time			4.5	_	0	0	ns
			6.0	_	0	0	
Minimum removal time			2.0	_	25	30	
(CLR, PR)	t _{rem}	_	4.5	_	5	6	ns
(CLR, PR)			6.0	_	4	5	
	f	_	2.0	_	6	5	
Clock frequency			4.5	_	31	25	MHz
			6.0		36	29	

AC Characteristics (C $_L$ = 15 pF, V_{CC} = 5 V, Ta = 25 $^{\circ}C,$ input: t_r = t_f = 6 ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH} t _{THL}	_	_	6	12	ns
Propagation delay time (CK-Q, \overline{Q})	t _{pLH}	_	_	13	26	ns
Propagation delay time (CLR , PR -Q, Q)	t _{pLH}	_	_	14	26	ns
Maximum clock frequency	f _{max}	_	36	77	_	MHz



AC Characteristics ($C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		-	Γa = 25°0		Ta = -40 to 85°C		Unit
	,		V _{CC} (V)	Min	Тур.	Max	Min	Max	
			2.0	_	30	75	_	95	
Output transition time	t _{TLH}	_	4.5	_	8	15	_	19	ns
	t _{THL}		6.0	_	7	13	_	16	
Propagation delay	4		2.0	_	48	150	_	190	
time	t _{pLH}	_	4.5	_	16	30	_	38	ns
$(CK-Q, \overline{Q})$	t _{pHL}		6.0	_	13	26	_	32	
Propagation delay			2.0	_	51	150	_	190	
time	t _{pLH}	_	4.5	_	17	30	_	38	ns
$(\overline{CLR}, \overline{PR}-Q, \overline{Q})$	t _{pHL}		6.0	_	15	26	_	32	
			2.0	6	21	_	5	_	
Maximum clock frequency	f _{max}	_	4.5	31	63	_	25	_	MHz
			6.0	36	67	_	29	_	
Input capacitance	C _{IN}	_		_	5	10	_	10	pF
Power dissipation capacitance	C _{PD}		(Note)		34	_		_	pF

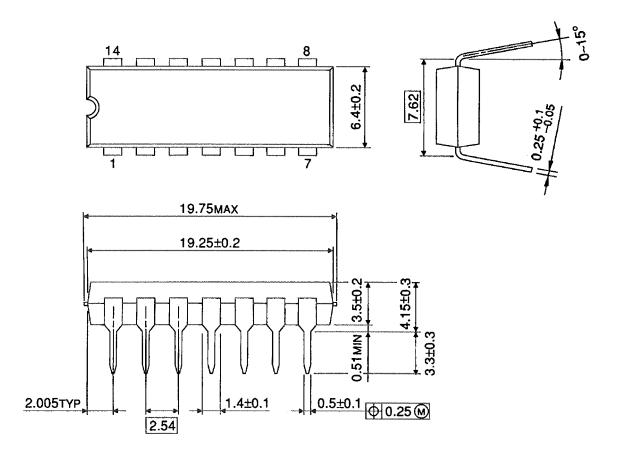
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$ (per F/F)

Package Dimensions

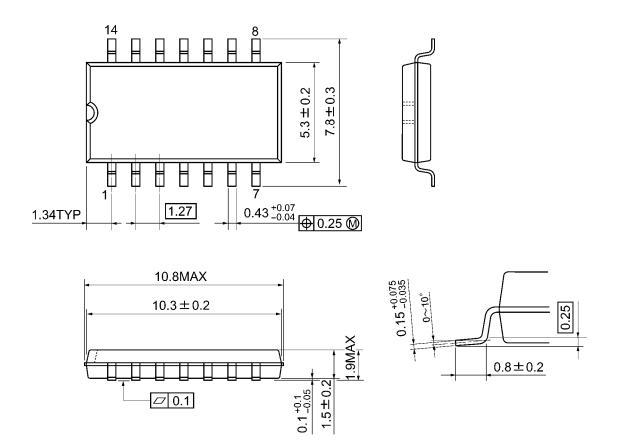
DIP14-P-300-2.54 Unit: mm



Weight: 0.96 g (typ.)

Package Dimensions

SOP14-P-300-1.27A Unit: mm



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Weight: 0.18 g (typ.)

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